

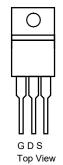
RoHS

COMPLIANT

## AUIRF1404Z-VB Datasheet N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY		
V <sub>DS</sub>	40	V
R <sub>DS(on)</sub> V <sub>GS</sub> = 10 V	2	mΩ
ID	180	А
Configuration	Sin	gle



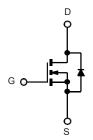


### FEATURES

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested

#### **APPLICATIONS**

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	ſ <sub>A</sub> = 25 °C, unless	otherwise note	d	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V <sub>DS</sub>	40	V
Gate-Source Voltage		V <sub>GS</sub>	± 20	- v
	T <sub>C</sub> = 25 °C		180 <sup>a, c</sup>	
Continuous Drain Current (T = $175 ^{\circ}$ C)	T <sub>C</sub> = 70 °C		150°	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>A</sub> = 25 °C	ID	29 <sup>b</sup>	A
	T <sub>A</sub> = 70 °C		23 <sup>b</sup>	
Pulsed Drain Current		I <sub>DM</sub>	350	
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	80	
Single Pulse Avalanche Energy	L = 0.1 IIIH	E <sub>AS</sub>	320	mJ
Continuous Source Drain Diado Current	T <sub>C</sub> = 25 °C 110 <sup>a, c</sup>		110 <sup>a, c</sup>	A
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	2.6 <sup>b</sup>	
	T <sub>C</sub> = 25 °C		312ª	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	200	w
	T <sub>A</sub> = 25 °C		3.13 <sup>b</sup>	VV
	T <sub>A</sub> = 70 °C		2.0 <sup>b</sup>	1
Operating Junction and Storage Temperature R	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	32	40	°C/W
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.33	0.4	C/W

Notes:

a. Based on  $T_C = 25$  °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.

Symbol V <sub>DS</sub> $\Delta$ V <sub>DS</sub> /T <sub>J</sub>	Test Conditions V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	Min.	Тур.	Max.	Unit	
	$V_{cc} = 0 V I_{c} = 250 \mu A$					
	$V_{cc} = 0 V I_{D} = 250 \mu A$		1	1	1	
$\Delta V_{DS}/T_{J}$	VGS 0 V, ID 200 µ. (	40			V	
	I <sub>D</sub> = 250 μA		41		mV/°	
$\Delta V_{GS(th)}/T_J$			- 8			
V <sub>GS(th)</sub>		2.0		4.0	V	
I <sub>GSS</sub>				± 100	nA	
lana	$V_{DS}$ = 40 V, $V_{GS}$ = 0 V			1	μA	
'DSS	$V_{DS}$ = 40 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10	μΑ	
I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			A	
D	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		2			
DS(on)	$V_{GS}$ = 4.5 V, I <sub>D</sub> = 20 A		15		mΩ	
9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A		180		S	
C <sub>iss</sub>			9000			
C <sub>oss</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, f = 1 MHz		650		pF	
C <sub>rss</sub>			450		-	
Qg			120			
Q <sub>as</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		30		nC	
Ű			16		-	
•	f = 1 MHz		0.85	1.3	Ω	
t <sub>d(on)</sub>			20	30		
t <sub>r</sub>	V <sub>DD</sub> = 20 V, R <sub>L</sub> = 1.0 Ω		11	17	1	
t <sub>d(off)</sub>	$I_D \cong 20 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{R}_{\text{g}} = 1 \Omega$		77	115	-	
t <sub>f</sub>			10	15	-	
t <sub>d(on)</sub>			102	155	ns	
t <sub>r</sub>	V <sub>DD</sub> = 20 V. R <sub>I</sub> = 1.0 Ω		62	95	-	
t <sub>d(off)</sub>	$I_D \cong 20 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		180	270	-	
	-		60	90	-	
 			1		1	
Is	T <sub>C</sub> = 25 °C			110		
I <sub>SM</sub>				200	A	
	I <sub>S</sub> = 20 A		0.8	1.2	V	
			50	75	ns	
1 1			70	105	nC	
	I <sub>F</sub> = 20 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C		-			
					ns	
	$\begin{array}{c} V_{GS(th)}\\ I_{GSS}\\ I_{DSS}\\ I_{D(on)}\\ R_{DS(on)}\\ g_{fs}\\ \hline\\ C_{iss}\\ C_{oss}\\ C_{rss}\\ Q_{g}\\ Q_{gs}\\ Q_{gd}\\ R_{g}\\ t_{d(on)}\\ t_{r}\\ t_{d(off)}\\ t_{f}\\ t_{d(off)}\\ t_{r}\\ t_{d(off)}\\ t_{f}\\ \hline\\ t_{d(off)}\\ t_{f}\\ \hline\\ t_{d(off)}\\ t_{f}\\ \hline\\ t_{f}\\ \hline\\ t_{d(off)}\\ t_{f}\\ \hline\\ t_{f}\\ \hline\\ t_{d(off)}\\ t_{f}\\ \hline\\ t_{f}\\ t_{f}\\ \hline\\ t_{f}\\ t_{t$	$\begin{array}{c c c c c c c } & V_{DS} = V_{GS}, I_{D} = 250 \ \mu A \\ \hline I_{GSS} & V_{DS} = 0 \ V, \ V_{GS} = 120 \ V \\ \hline V_{DS} = 40 \ V, \ V_{GS} = 0 \ V, \ T_{J} = 55 \ ^{\circ}C \\ \hline I_{D(on)} & V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline V_{DS} \ge 5 \ V, \ V_{GS} = 10 \ V \\ \hline R_{DS(on)} & V_{GS} = 15 \ V, \ I_{D} = 30 \ A \\ \hline V_{GS} = 4.5 \ V, \ I_{D} = 20 \ A \\ \hline V_{GS} = 15 \ V, \ I_{D} = 30 \ A \\ \hline V_{GS} = 15 \ V, \ I_{D} = 30 \ A \\ \hline V_{GS} = 15 \ V, \ I_{D} = 30 \ A \\ \hline V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 20 \ V, \ V_{GS} = 0 \ V, \ f = 1 \ MHz \\ \hline C_{rss} & V_{DS} = 20 \ V, \ V_{GS} = 10 \ V, \ I_{D} = 20 \ A \\ \hline Q_{gd} & V_{DS} = 20 \ V, \ V_{GS} = 10 \ V, \ I_{D} = 20 \ A \\ \hline Q_{gd} & f = 1 \ MHz \\ \hline I_{d(on)} & I_{D} \cong 20 \ V, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \\ \hline I_{d} (on) & I_{D} \cong 20 \ V, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \\ \hline I_{d} (on) & I_{D} \cong 20 \ V, \ V_{GEN} = 10 \ V, \ R_{g} = 1 \ \Omega \\ \hline I_{d} (on) & I_{D} \cong 20 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline I_{d} (on) & I_{D} \cong 20 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline I_{d} (on) & I_{D} \cong 20 \ A, \ V_{GEN} = 4.5 \ V, \ R_{g} = 1 \ \Omega \\ \hline I_{S} & T_{C} = 25 \ ^{\circ}C \\ \hline I_{SM} & I_{F} = 20 \ A, \ di/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline I_{a} & I_{F} = 20 \ A, \ di/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline V_{a} & I_{F} = 20 \ A, \ di/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline V_{a} & I_{F} = 20 \ A, \ di/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline V_{a} & I_{F} = 20 \ A, \ di/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline V_{a} & I_{F} = 20 \ A, \ di/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline V_{a} & I_{F} = 20 \ A, \ di/dt = 100 \ A/\mus, \ T_{J} = 25 \ ^{\circ}C \\ \hline V_{a} & I_{F} = 20 \ ^{\circ}C \ V_{a} \\ \hline V_{a} & I_{F} = 20 \ ^{\circ}C \ V_{a} \\ \hline V_{a} & I_{F} = 20 \ ^{\circ}C \ ^{$	$\begin{array}{c c c c c c c c } V_{GS}(h) & V_{DS} = V_{GS}, I_{D} = 250 \ \mu A & 2.0 \\ \hline I_{GSS} & V_{DS} = 0 \ V, V_{GS} = \pm 20 \ V & \\ \hline V_{DS} = 40 \ V, V_{GS} = 0 \ V, T_{J} = 55 \ ^{\circ}C & \\ \hline I_{D(on)} & V_{DS} \geq 5 \ V, V_{GS} = 10 \ V & 120 \\ \hline V_{CS} = 10 \ V, I_{D} = 30 \ A & \\ \hline V_{CS} = 4.5 \ V, I_{D} = 20 \ A & \\ \hline V_{DS} = 4.5 \ V, I_{D} = 20 \ A & \\ \hline V_{DS} = 15 \ V, I_{D} = 30 \ A & \\ \hline V_{DS} = 15 \ V, I_{D} = 30 \ A & \\ \hline V_{DS} = 15 \ V, I_{D} = 30 \ A & \\ \hline V_{DS} = 15 \ V, I_{D} = 20 \ A & \\ \hline Q_{g} & \\ \hline I_{T} & \\ \hline V_{DS} = 20 \ V, V_{GS} = 10 \ V, I_{D} = 20 \ A & \\ \hline D_{D} = 20 \ V, R_{L} = 1.0 \ \Omega & \\ \hline I_{D} \cong 20 \ A, \ V_{GEN} = 10 \ V, R_{g} = 1 \ \Omega & \\ \hline I_{D} \cong 20 \ A, \ V_{GEN} = 10 \ V, R_{g} = 1 \ \Omega & \\ \hline I_{D} \cong 20 \ A, \ V_{GEN} = 4.5 \ V, R_{g} = 1 \ \Omega & \\ \hline I_{D} \cong 20 \ A, \ V_{GEN} = 4.5 \ V, R_{g} = 1 \ \Omega & \\ \hline I_{S} & \hline T_{C} = 25 \ ^{\circ}C & \\ \hline I_{SM} & \\ \hline V_{SD} & I_{S} = 20 \ A, \ I_{S} = 20 \ A & \\ \hline I_{F} = 20 \ A, \ di/dt = 100 \ A/\mu_{S}, \ T_{J} = 25 \ ^{\circ}C & \\ \hline \hline I_{S} & \\ \hline I_{F} = 20 \ A, \ di/dt = 100 \ A/\mu_{S}, \ T_{J} = 25 \ ^{\circ}C & \\ \hline \hline \hline D_{T} & \hline D_{T} & \\ \hline \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

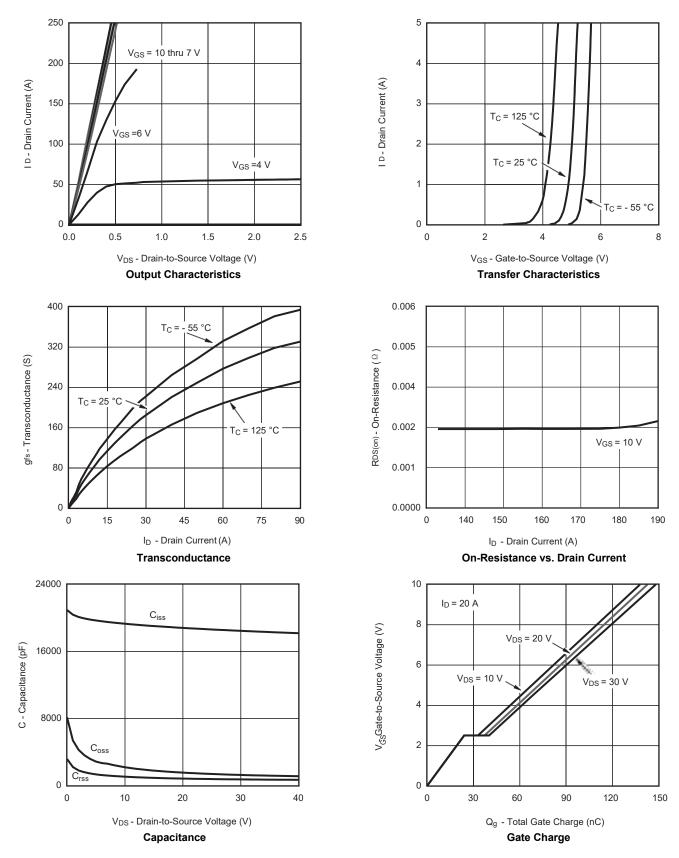
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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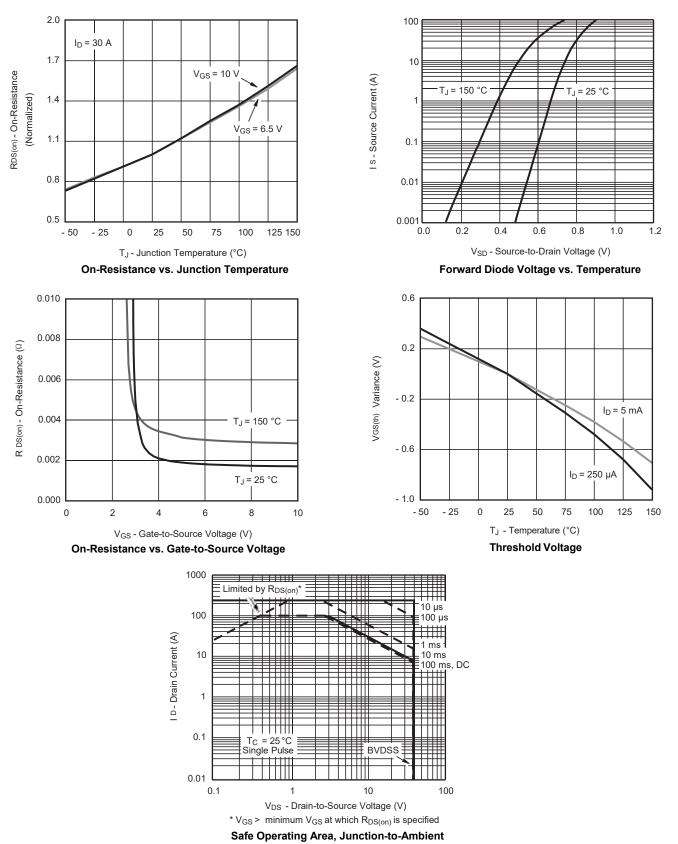
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

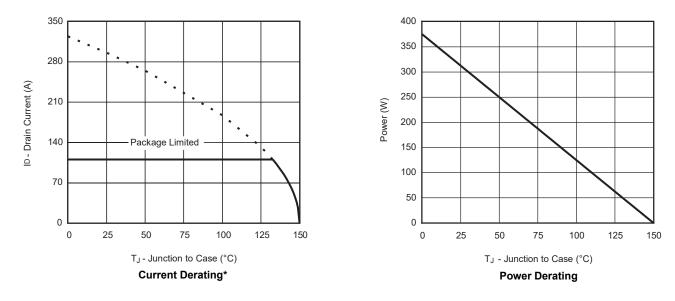


服务热线:400-655-8788



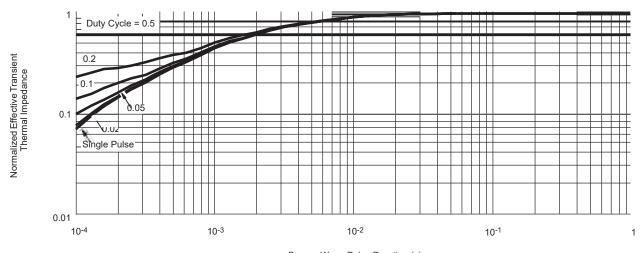
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\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

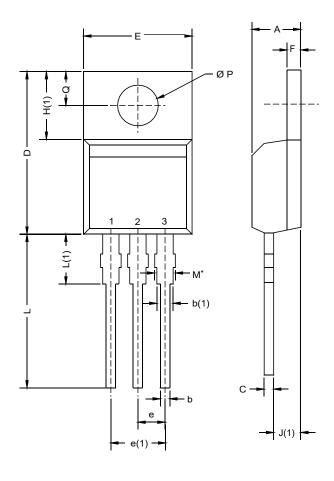


Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

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## **TO-220AB**



	MILLIM	ETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
E	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	
ECN: X12- DWG: 547	0208-Rev. N, 1	08-Oct-12			

#### Notes

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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